

Discs: prototyping, FEA, & next steps

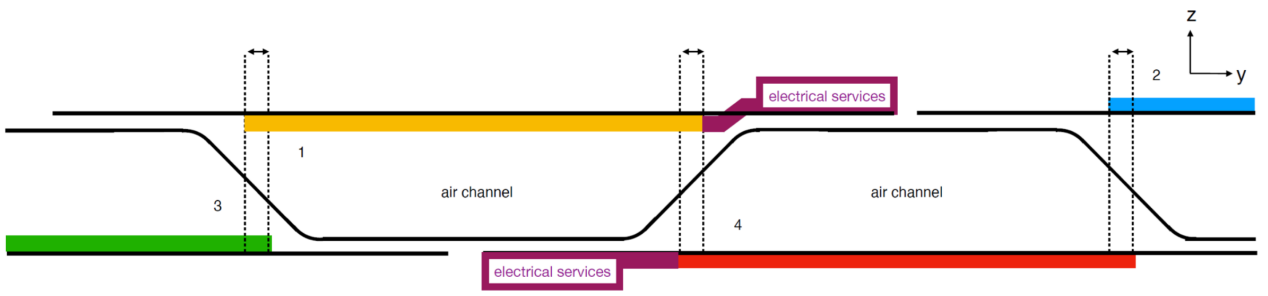
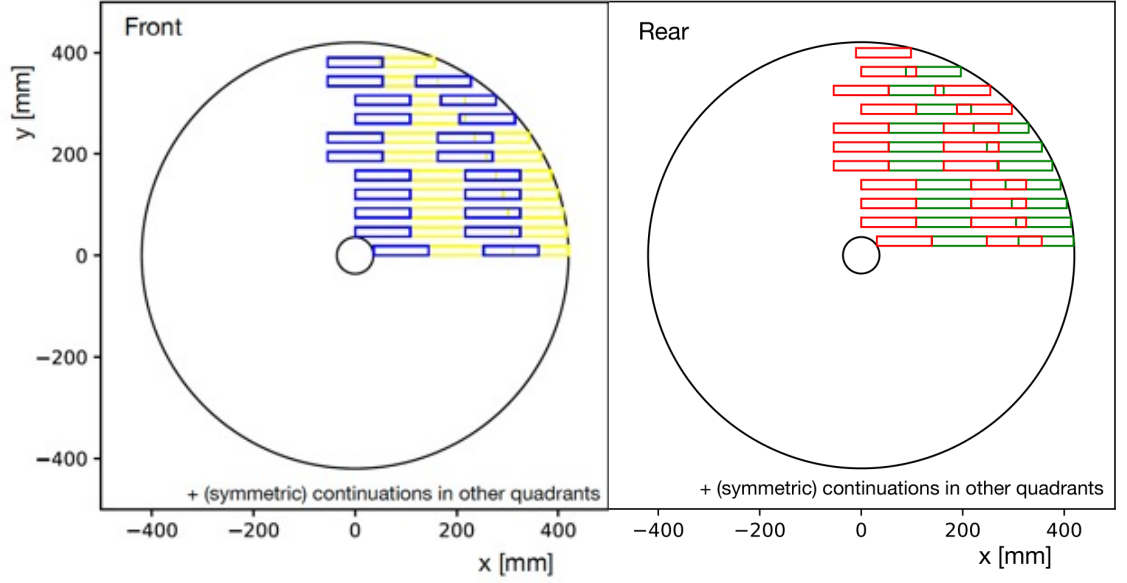
Nikki Apadula

ePIC Collaboration Meeting

January 23, 2025

Corrugated disc design

- Front and rear facing constructed from modules
- Two module types:
 - **Outward facing** (sensor facing outward from corrugation)
 - **Inward facing** (sensor facing inward to corrugation)

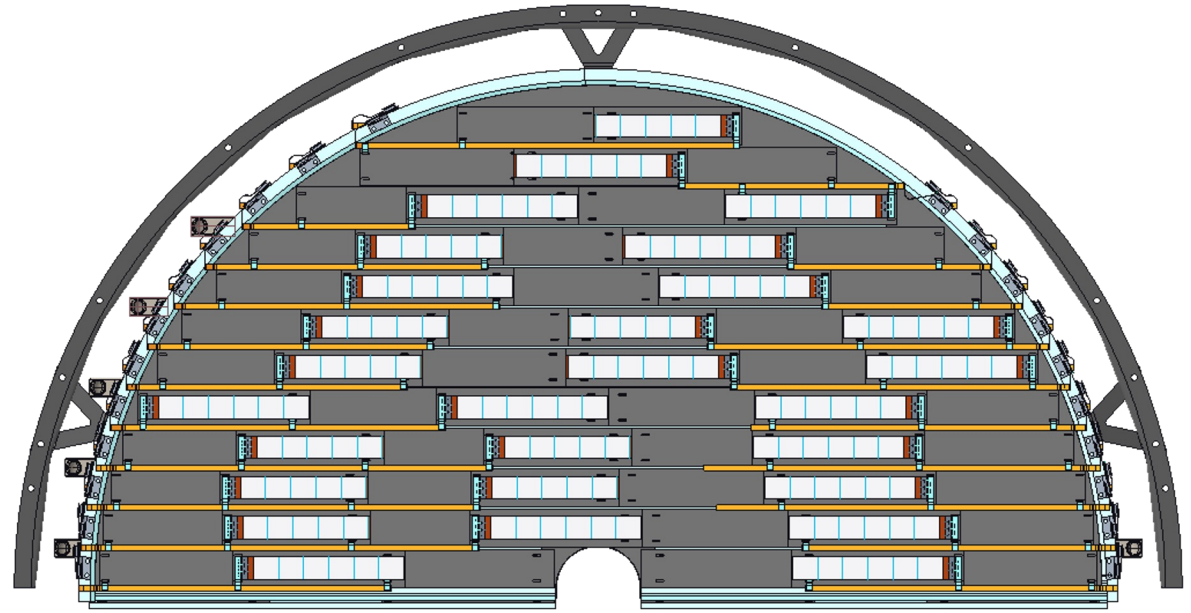
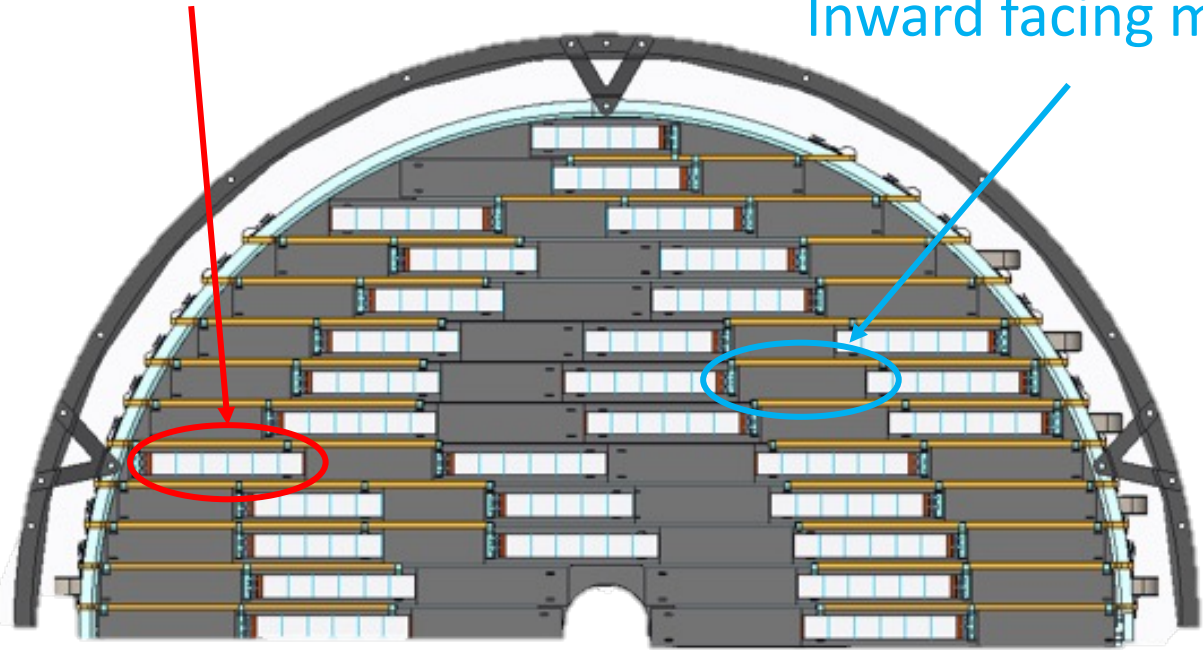


Sensor layout

Sensor layout changes disc to disc with changing inner radius
→ New beam pipe changes means re-doing the sensor layout

Outward facing module

Inward facing module



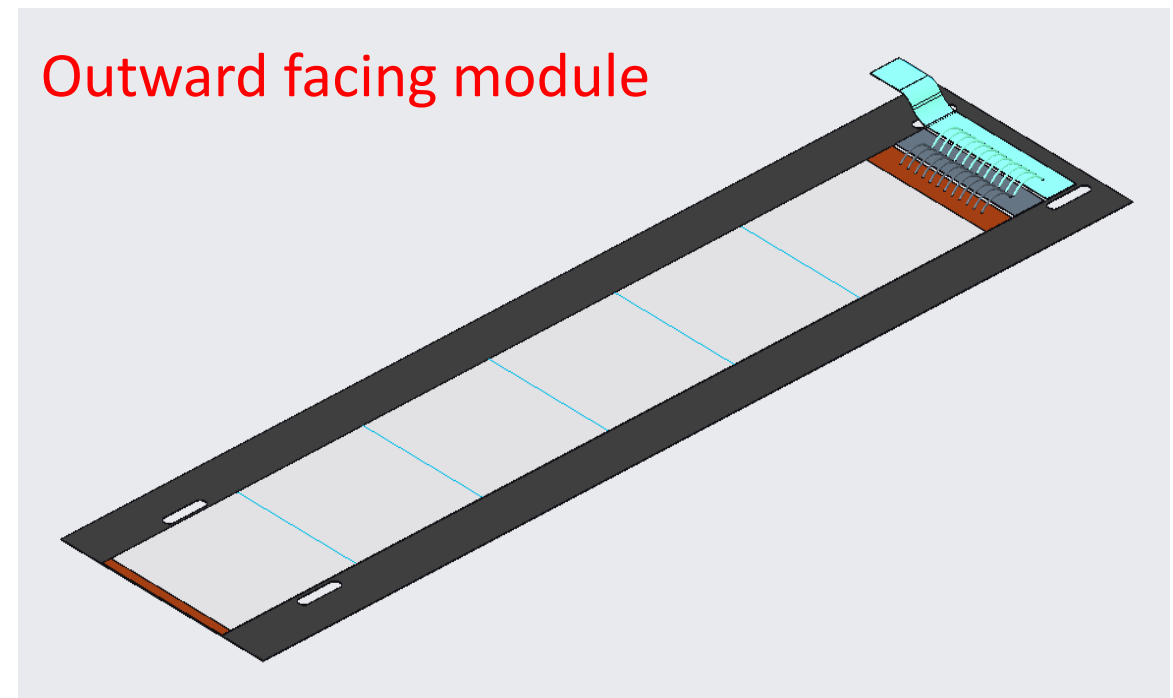
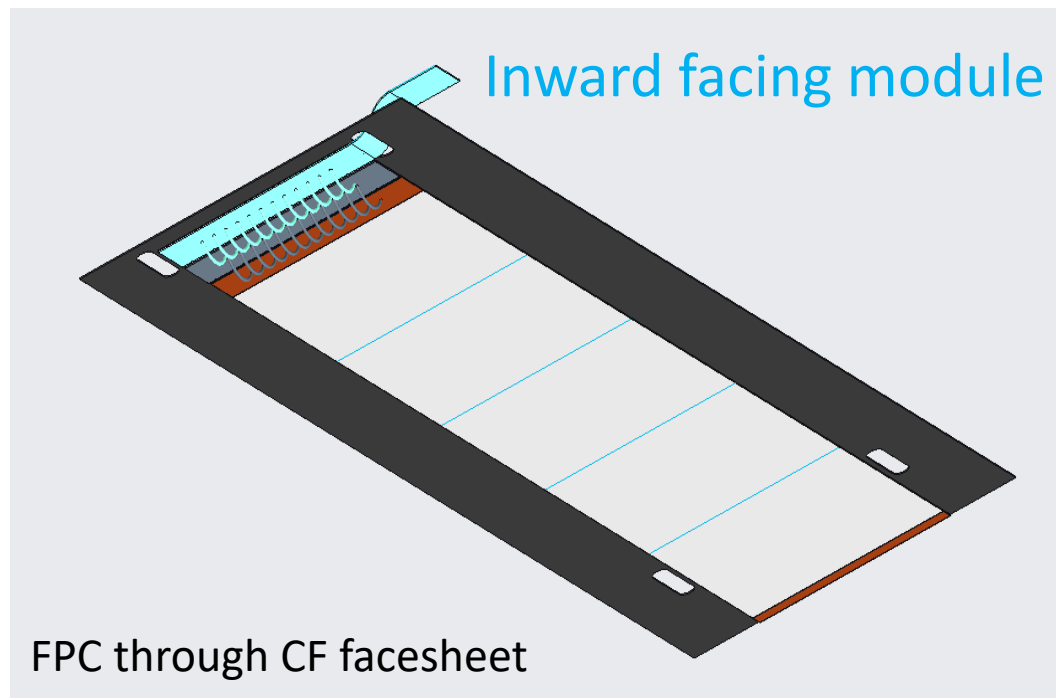
"Front" face of disc (facing in to IP)

"Back" face of disc (facing away from IP)

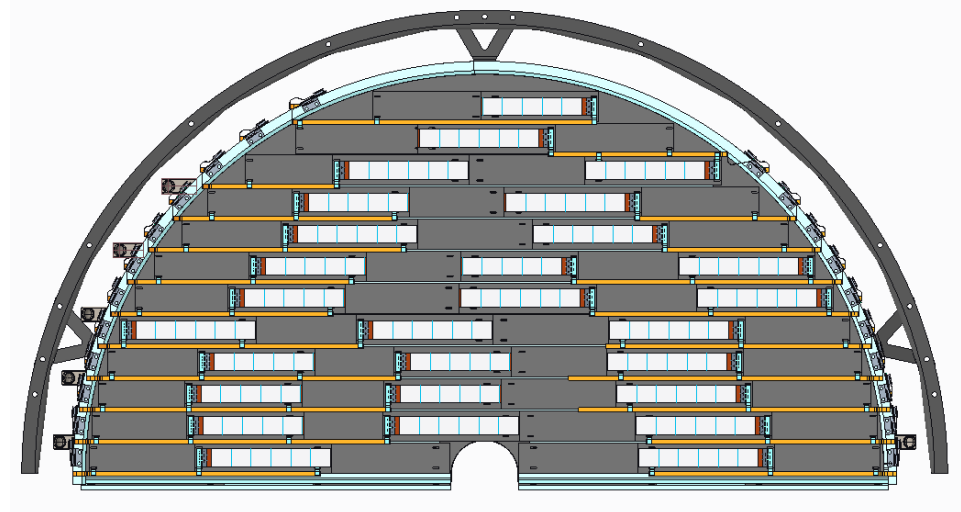
****This will change to ensure we aren't mixing 5 & 6 RSUs on same FPC**

Modules

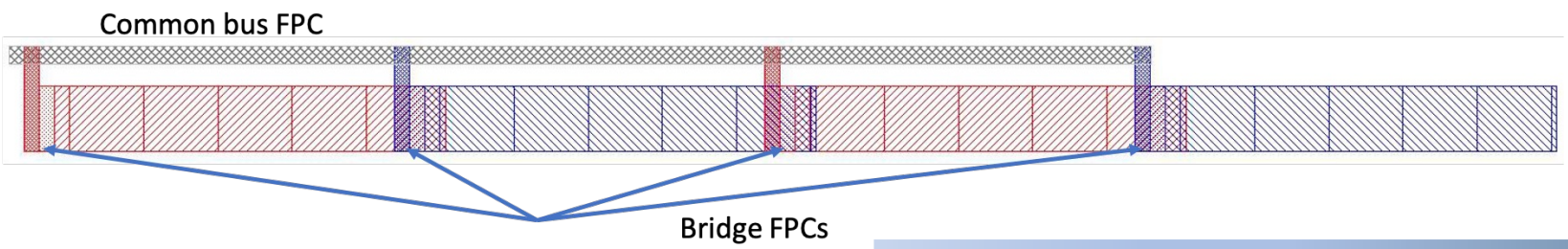
- One sensor glued to a carbon fiber sheet & bonded to an Ancillary ASIC (AncASIC) and Flexible Printed Circuit (FPC)
- New information about AncASIC to be incorporated



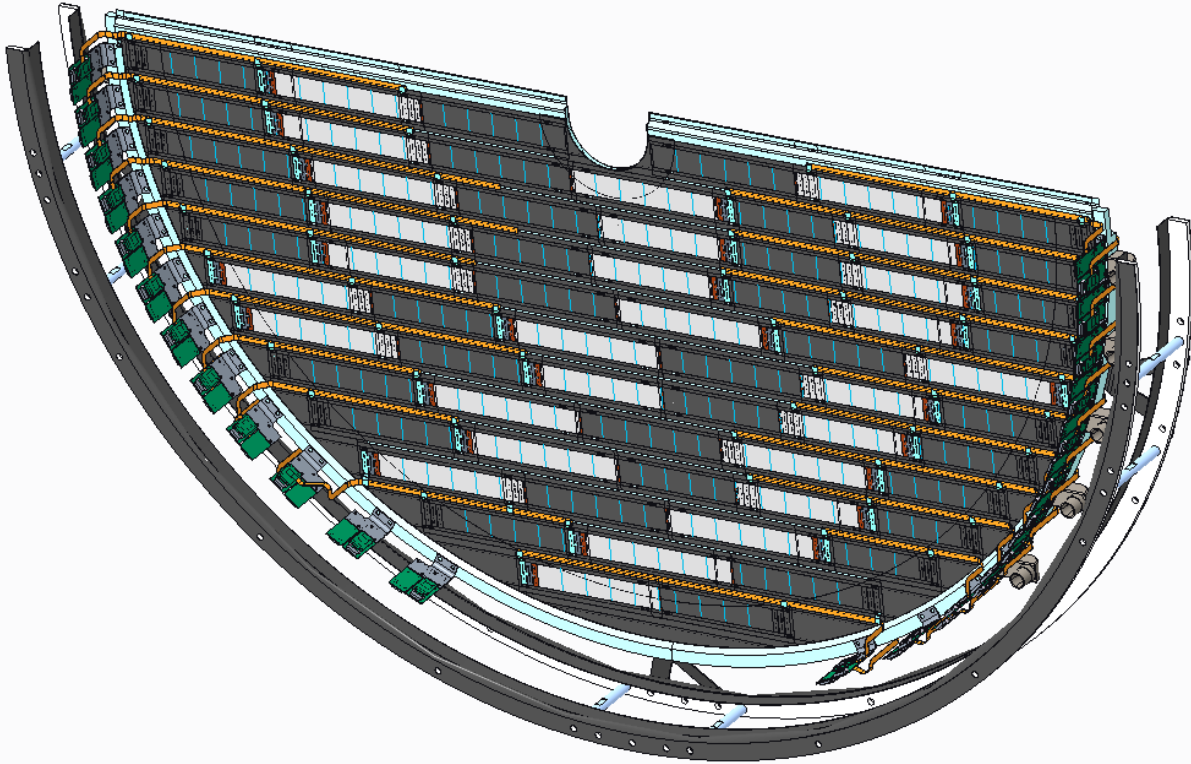
Module grouping & FPC



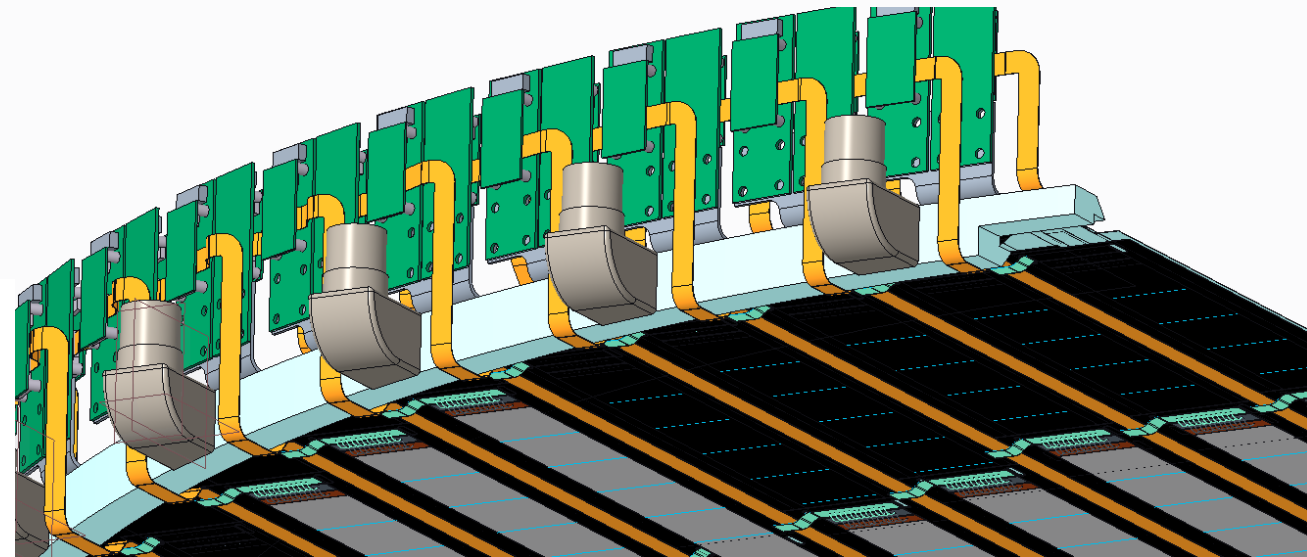
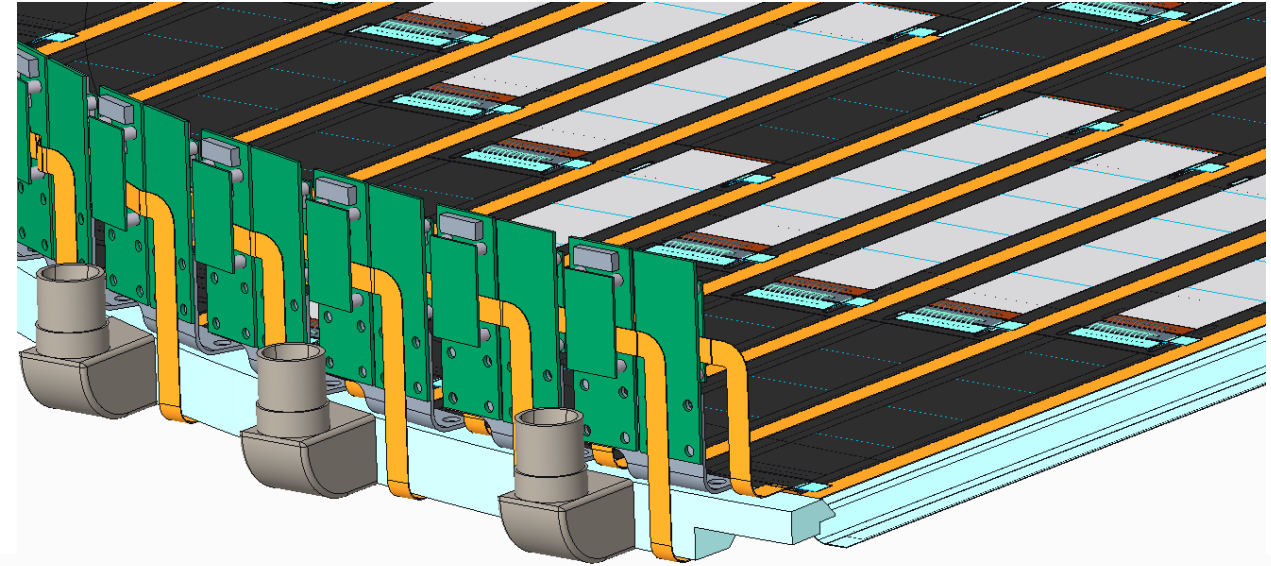
- 1 bridge FPC per module → up to 4 modules per common FPC
- Unlike OB, Discs need varying distances between bridge FPCs
- Bridge FPC & (likely) AncASIC will be bonded during module assembly
- Bridge FPCs need to connect to common FPC after gluing to corrugation
 - Bridge to common connection needs to happen on the disc → prefer to solder, otherwise disc needs to be moved to wire bonding machine



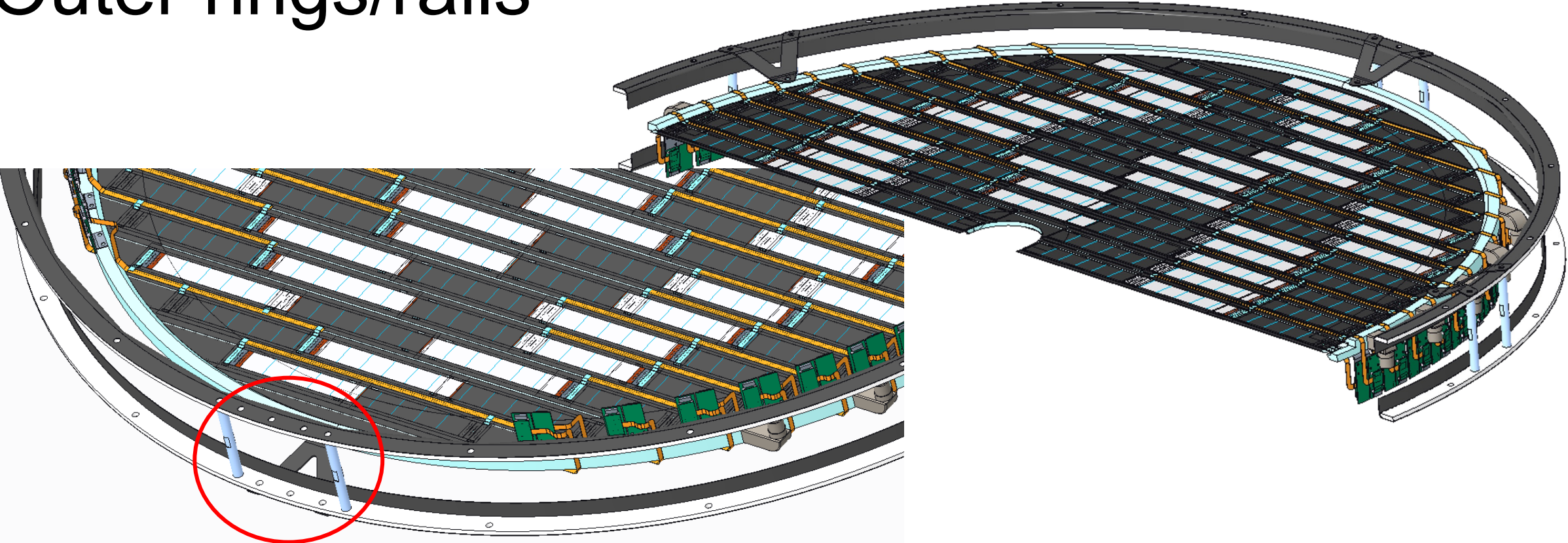
Readout boards



- Arranged around outer radius of disc
- Point away from IP
- Size and shape a first estimate
 - Needs refinement with new information



Outer rings/rails

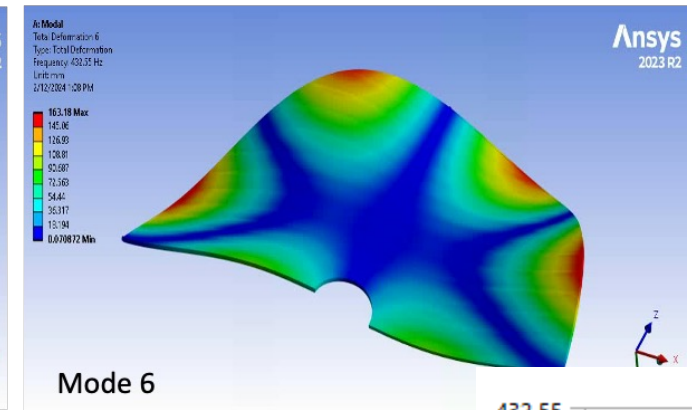
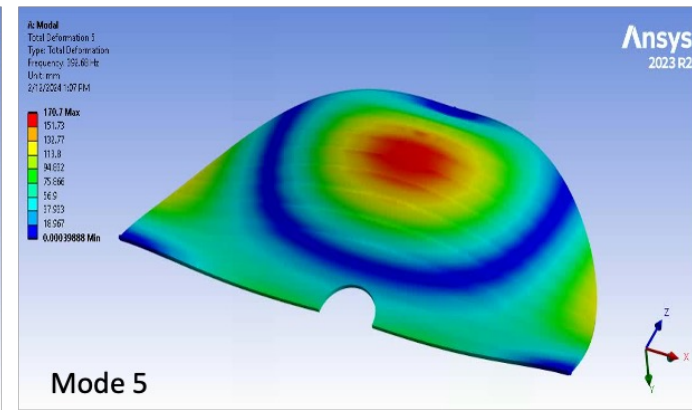
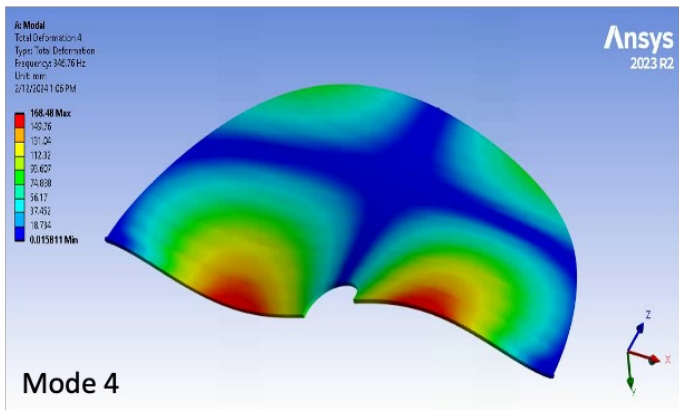
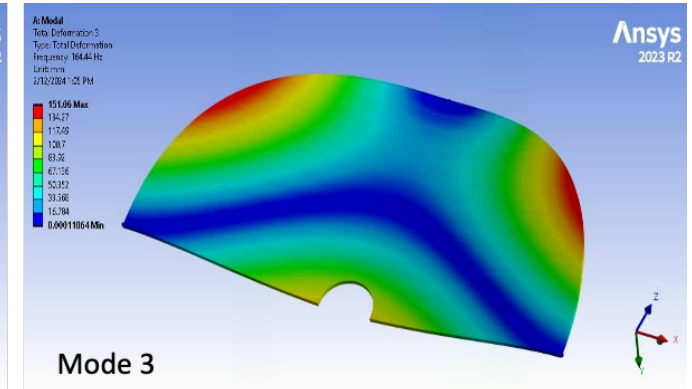
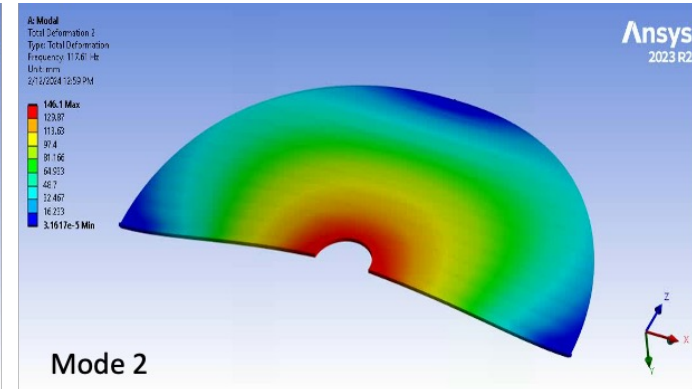
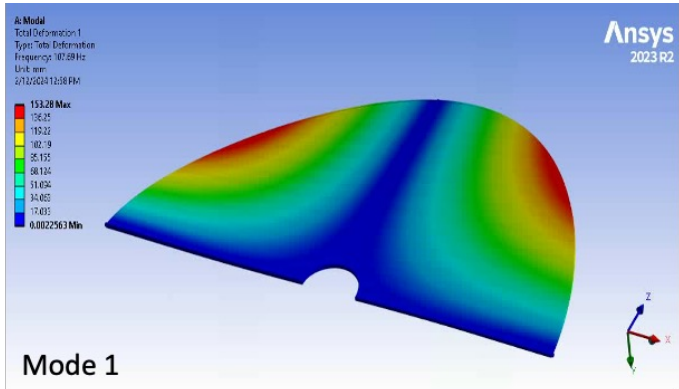


Outer rails allow for resting points for the discs during construction

- Outer ring provides structural support and sandwiches both sides of the disc
- Need for outer rail TBD depending on connection to support tube (IST)

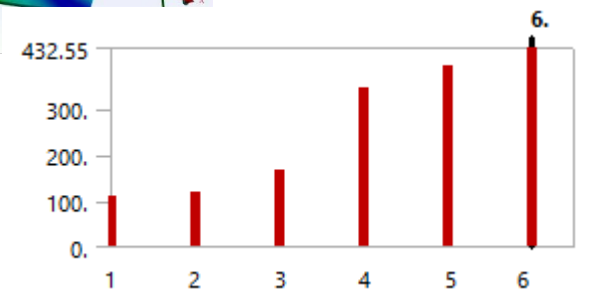
Natural frequency

Corrugated Disc of 6 mm Height – Rev 2 (Mesh size = 2 mm)



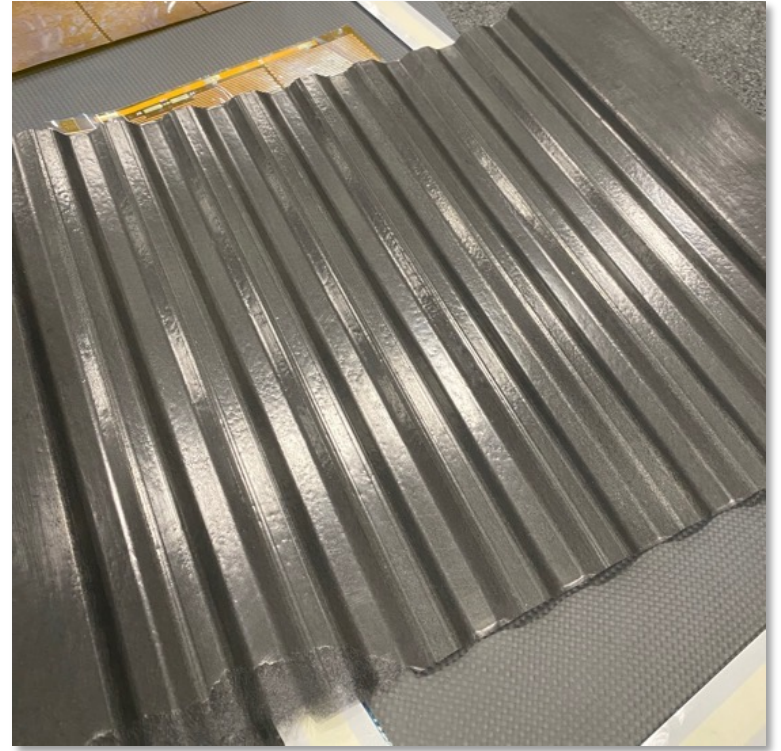
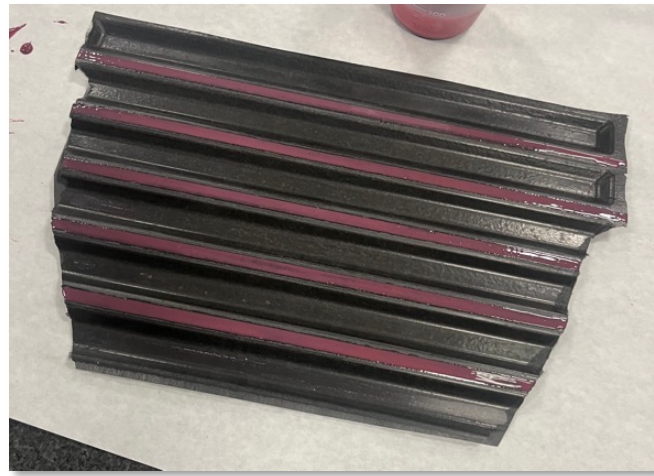
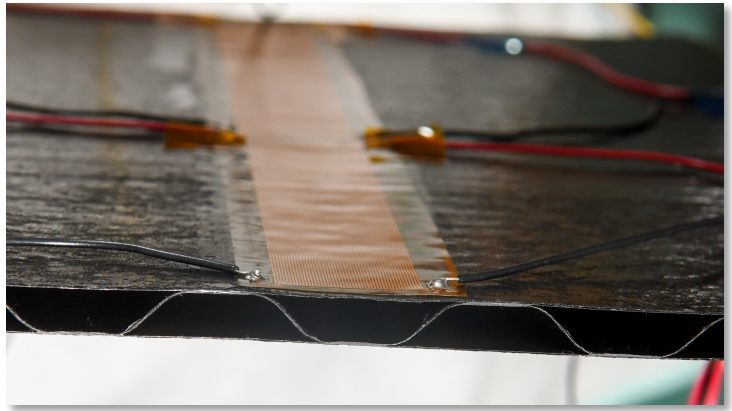
Mode	Frequency [Hz]
1.	107.69
2.	117.61
3.	164.44
4.	346.76
5.	392.68
6.	432.55

First mode > 100 Hz
Promising first result

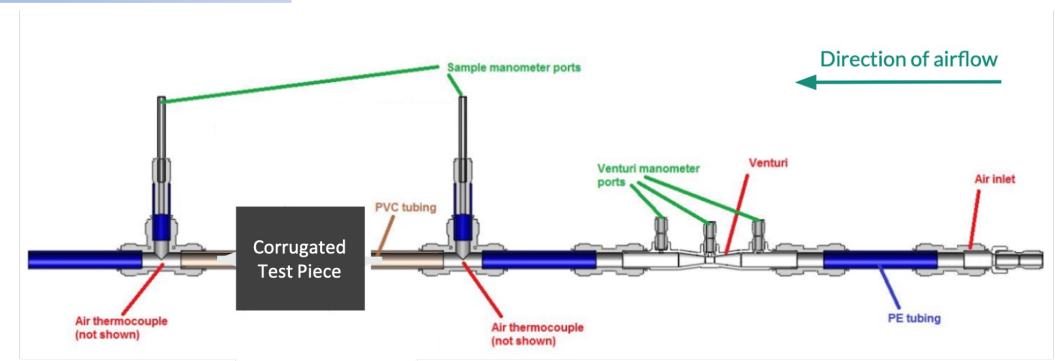


First prototype test piece

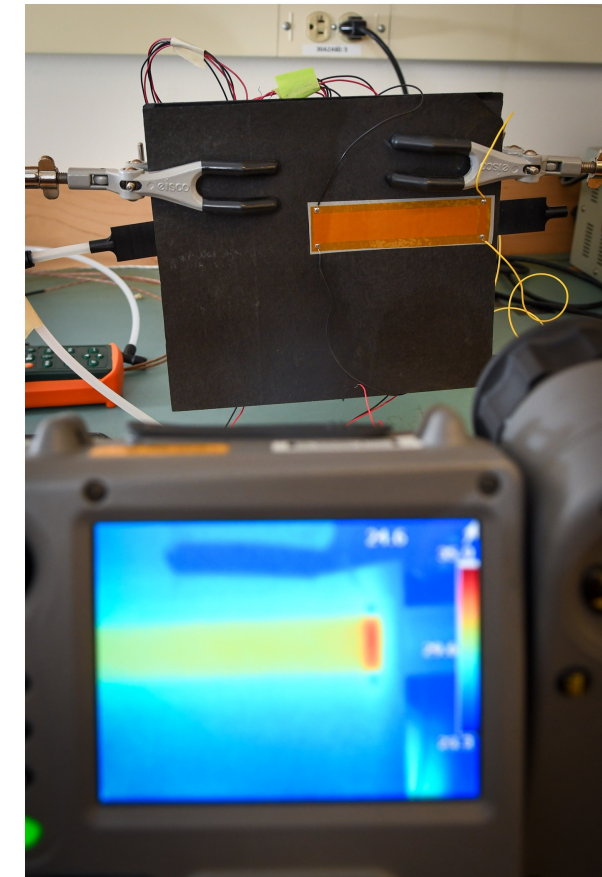
- 2 layers 34 gsm veil & 5 layers 10 gsm resin
- Face sheet glued with 9309 adhesive in 5 mm strips
- Density = 497 gsm \rightarrow $\sim 0.12\%$ X/X_0



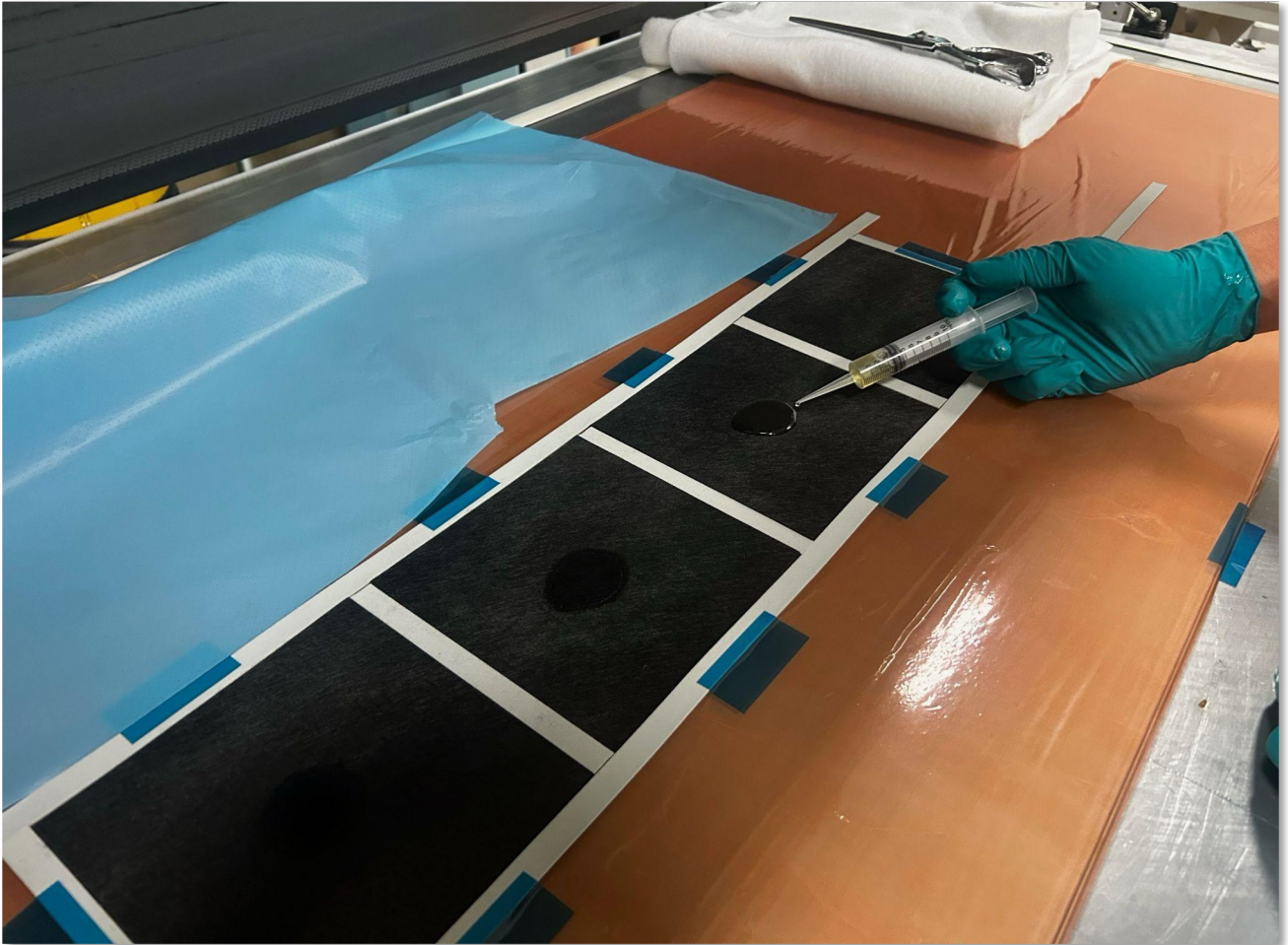
Discs: previous results



- Cooling through corrugated carbon veil (first prototype)
- Thermal studies using PGS (graphite) & unidirectional carbon fiber (K13C2U)

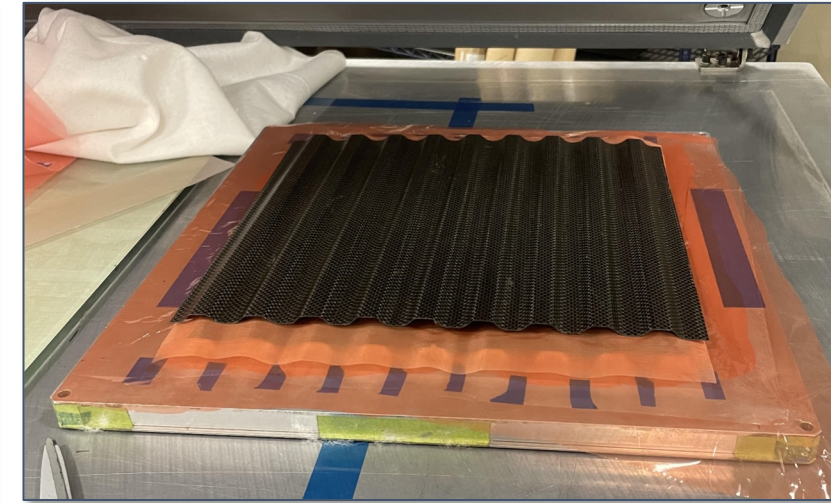
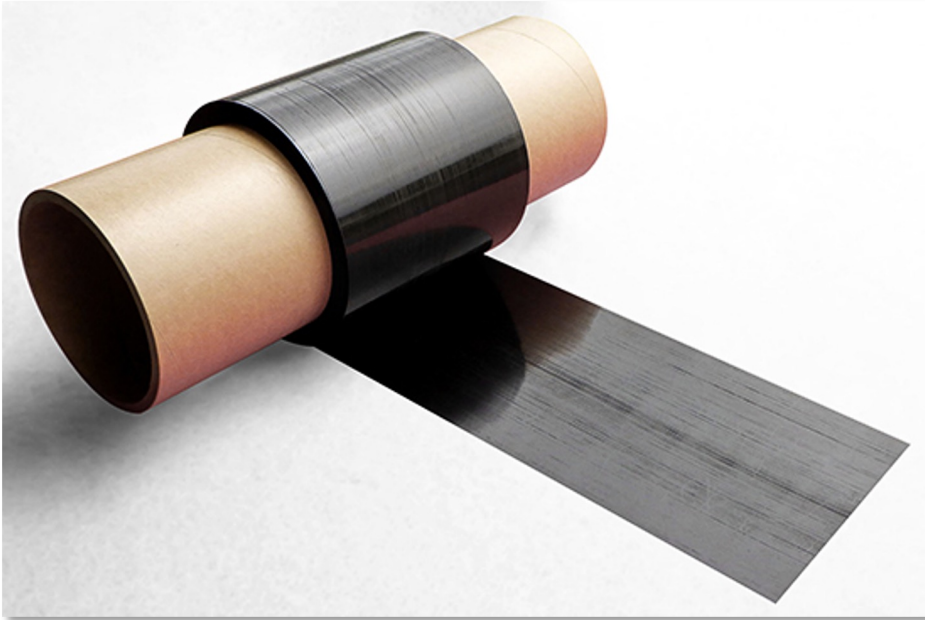


Carbon composite layup



- First prototype: Used carbon veil and 10 gsm resin
 - Veil was difficult to get on and off tooling and get fully wetted
 - Tried wet layup (liquid resin) → didn't spread evenly through the layers, mass is difficult to control
- Moved on to unidirectional fiber for next prototypes

New prototypes



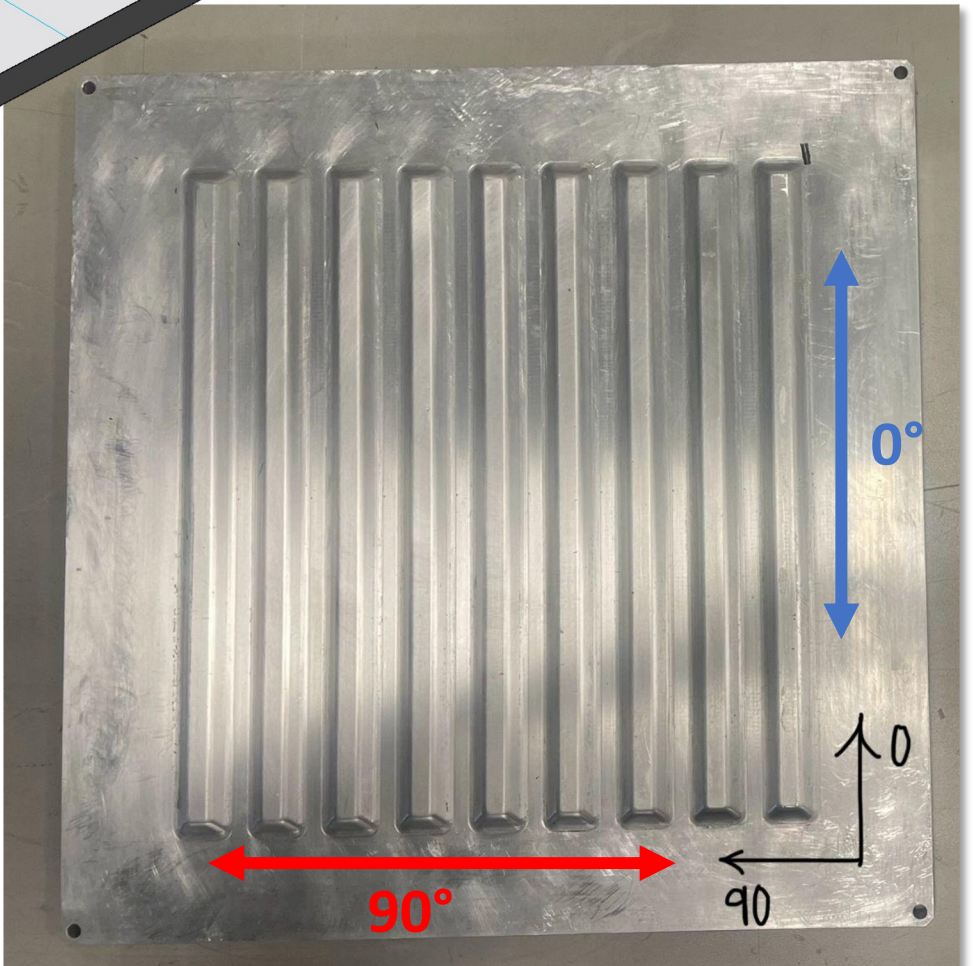
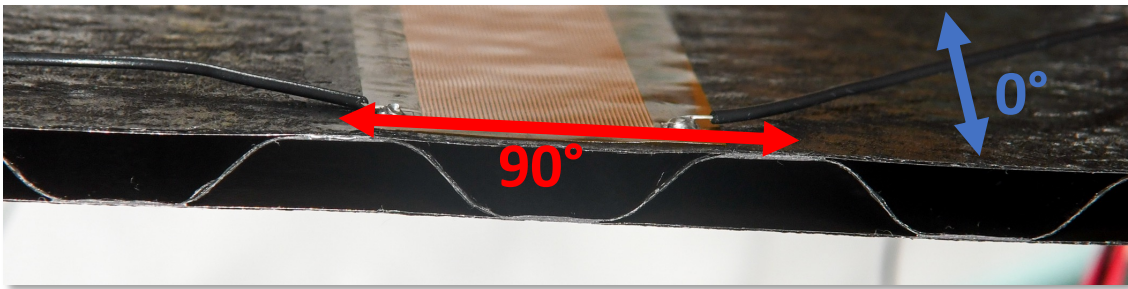
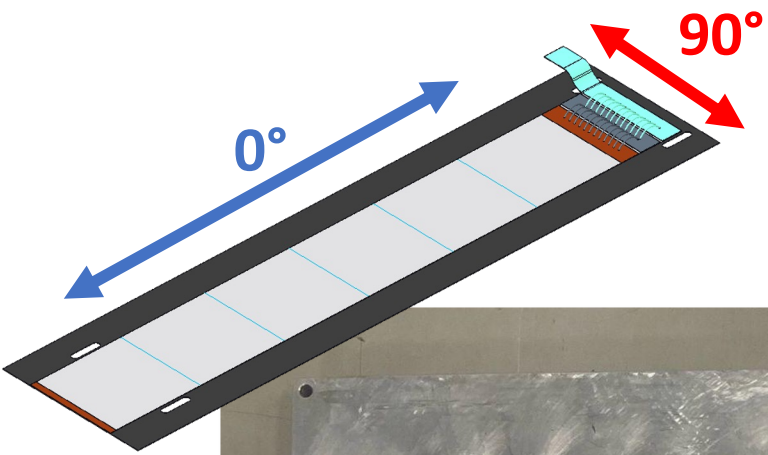
K13C2U Carbon Fiber

- unidirectional
- high thermal conductivity

Caul plate created out of a heavy weave (CN80) to hold K13 in place and distribute vacuum pressure equally

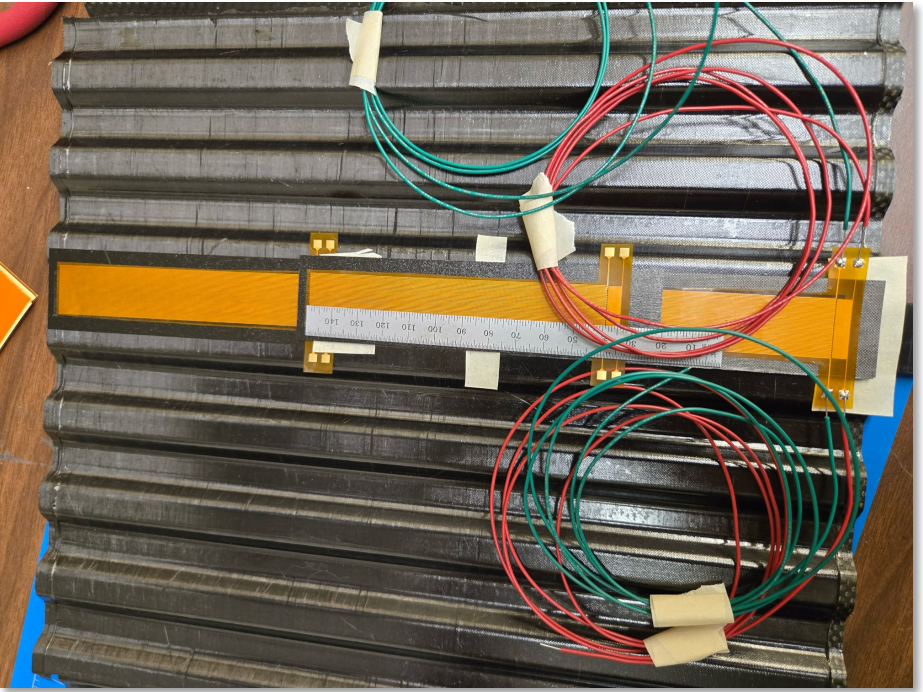
Layup orientation

- 0°: along the corrugation
- 90°: against the corrugation
- Tested two different configurations
 - 0/90/0 → thermal & mechanical advantage on module flat sheet
 - 90/0/90 → mechanical advantage for corrugation



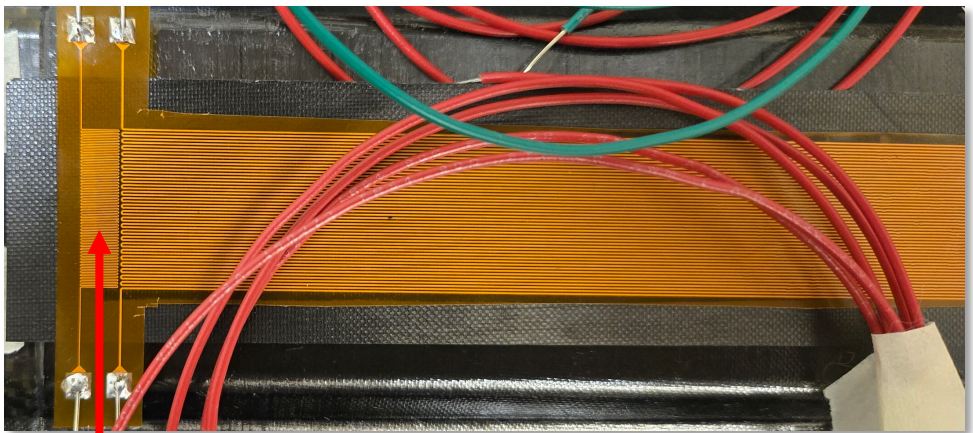
Second test piece

- Modules → size and shape close to expected
 - Width: 1.5 mm < pitch. Length: 1.5 cm > EIC-LAS
 - Refined carbon fiber cutting technique for straighter edges & better precision
- Attaching modules to corrugation
 - Using caul plate as support for the corrugation during module attachment
 - Lining up modules using tape and straight edges
- All adhesion done using 3M 467MP double-sided tape, 60 μm thick (used for STAR HFT)
 - Other glues to be tested (e.g. hysol 9309 for module to corrugation)



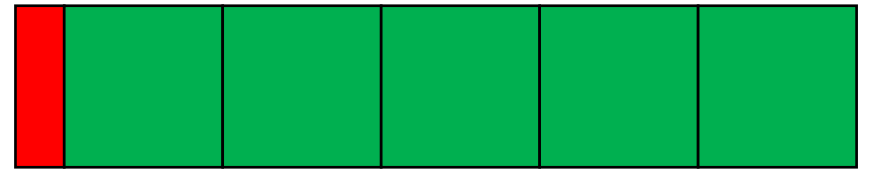
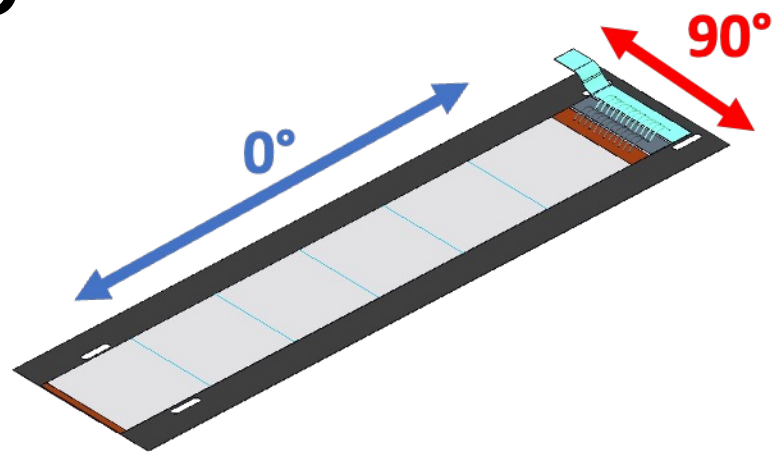
Modules: thermal performance

Heaters: 2 power regions



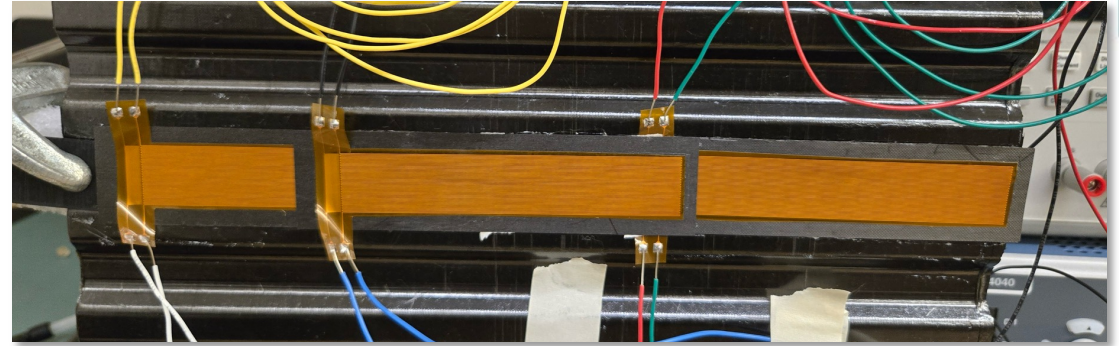
LEC

RSU region
5 RSU size



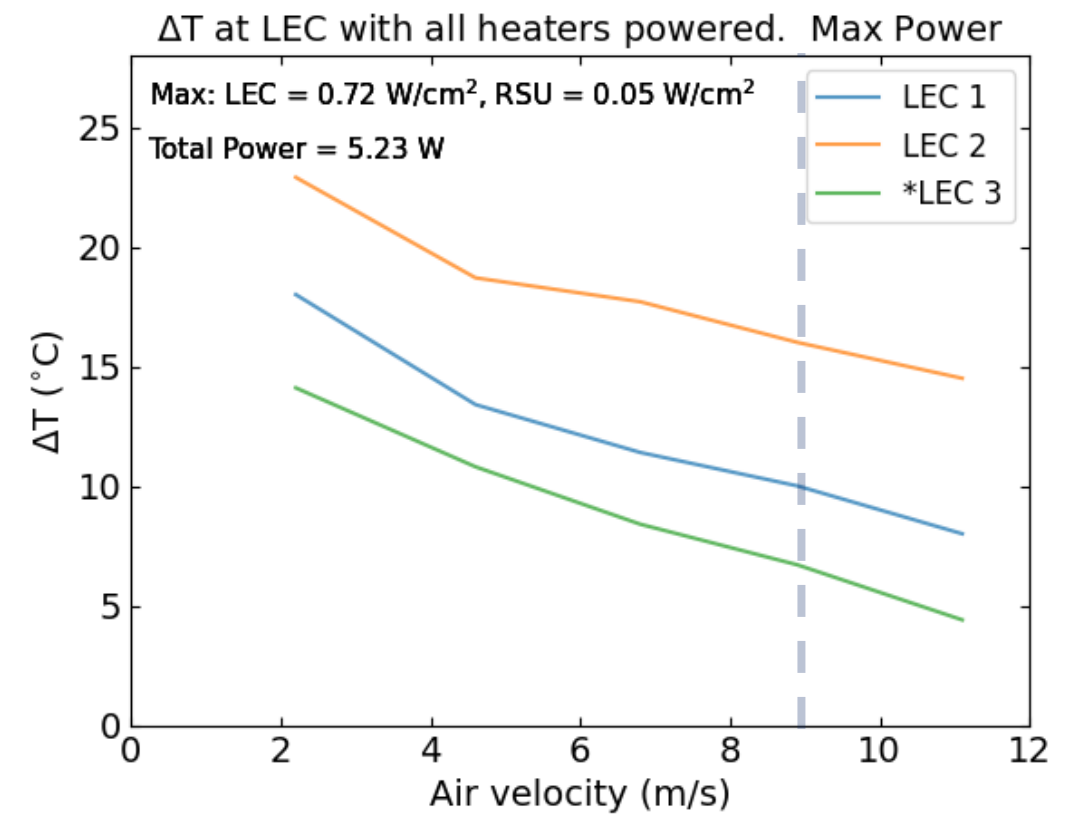
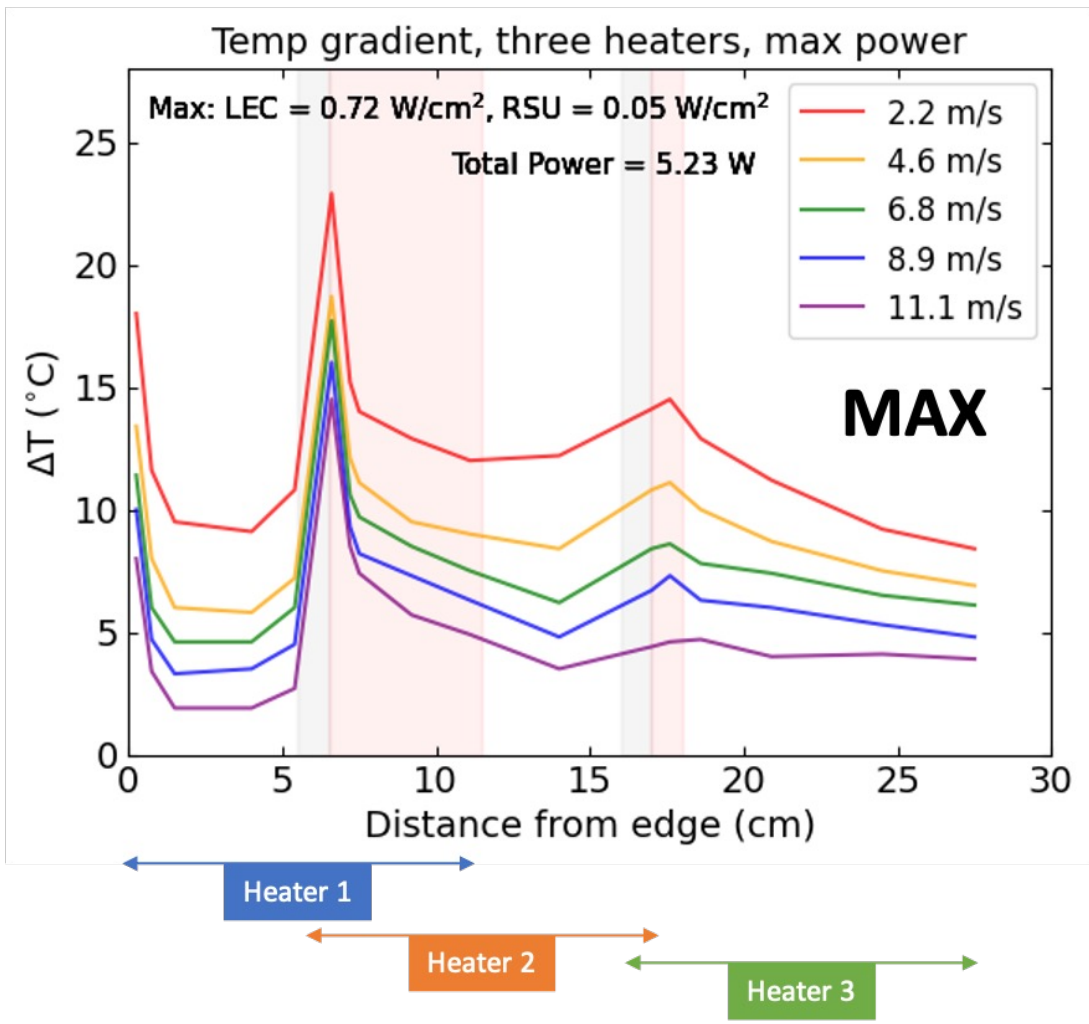
Each power region powered separately
Capable of a range of power densities

New thermal prototype



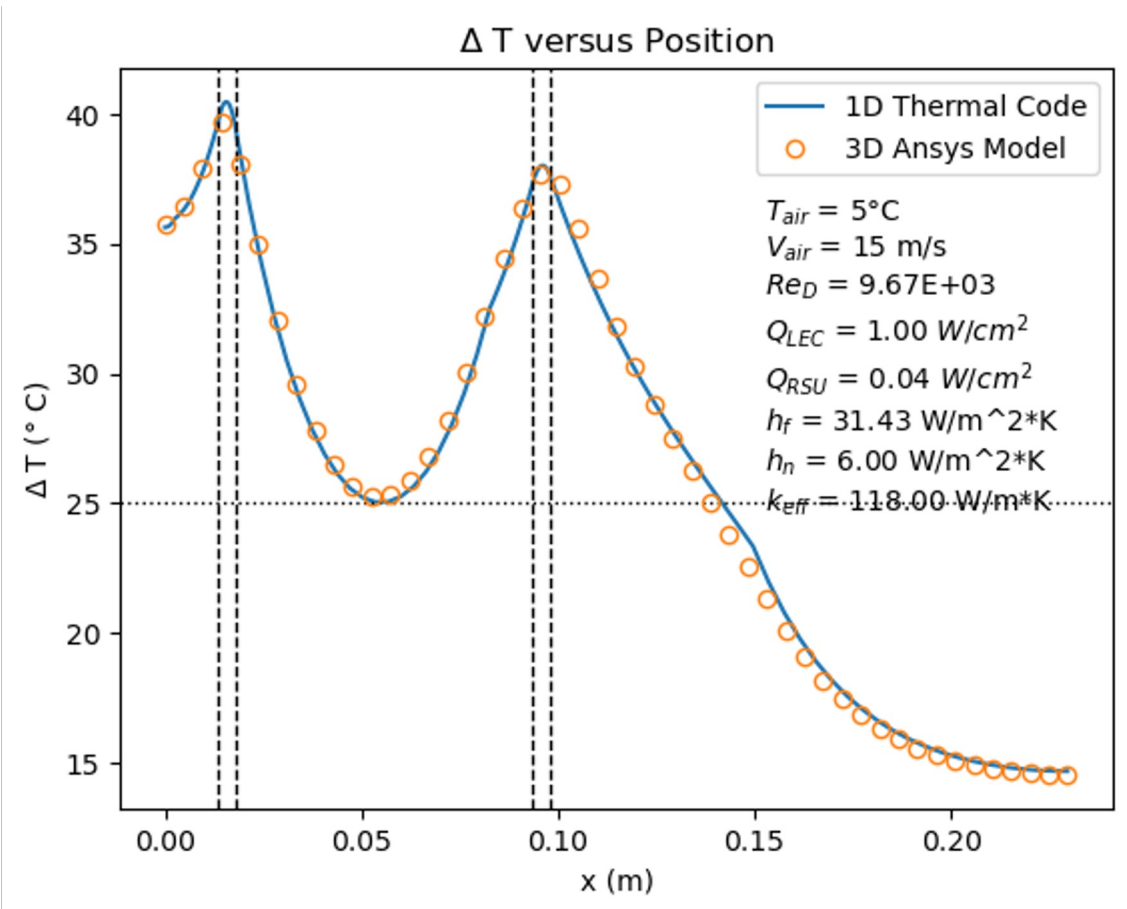
- Three heaters placed on one corrugated channel
- Two overlap regions
 - Large ($\sim 1/2$ the heater length)
 - Minimal (\sim LEC length)
- Configuration: outward facing only
- Tested at two different powers, MAX and MIN (in this case, MIN is the nominal value given by the sensor designers)
- Held in same orientation as planned in ePIC

New thermal results



At 9 m/s:
 RSU ΔT < 10°C for MAX and < 5°C for MIN
 LEC ΔT < 20°C for MAX and < 15°C for MIN

Thermal FEA



- 1D thermal code for quick changes and system wide calculations
- Comparison to 3D Ansys model shows good agreement
- Working on comparing to test bench results
 - Shape matches well to overlap test bench data

One example: Air velocity and temp to be further explored

Next steps/plans

- Continuation of thermal studies → add AncASIC thermal dummy. **1 month**
- Develop tooling for module prototyping → sensor handling and alignment
 - First set needs to be ready for dummy sensors. **2-3 months**
- Develop tooling for disc prototyping → module handling and alignment
 - Develop in parallel to module tooling. **3-4 months**
- Vibration study of corrugation in wind tunnel **2-3 months**
- Mechanical model and FEA **Continuous**
- Thermal model and FEA. **Continuous**
- Module prototypes
 - With dummy silicon for handling, alignment, tooling, mechanical tests. First pieces ready before thermomechanical dummies arrive. **Late spring '25**
 - With thermomechanical dummies for thermal studies → intent to be ready as soon as thermomechanical dummies are available. **Late summer '25**
- Disc prototypes (after module prototypes)
 - With dummy mechanical modules for handling, alignment, tooling, mechanical tests **Late spring, early summer**
 - With thermomechanical dummies for thermal studies **Late summer, early fall**
 - Tooling checks for gluing on both sides of the disc **Over the course of the year. Finalization towards end '25**

Backups

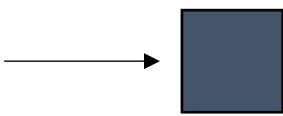
Sensor Power Regions

*Snapshot → new numbers shown today

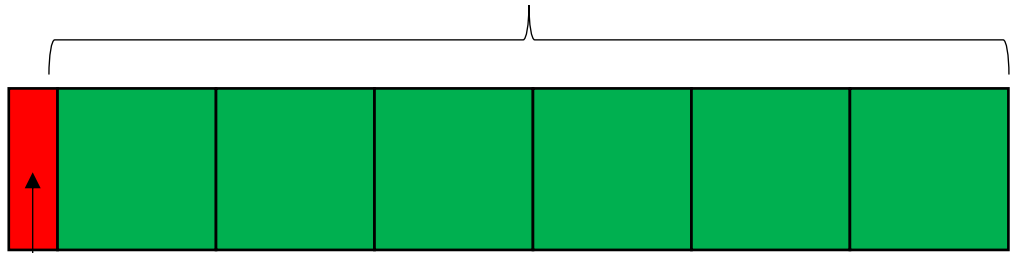
Information from [Iain](#) and [Georg's](#) presentations at previous SVT meetings*

EIC-LAS

AncASIC:
Max: 45% of LAS
Min: 35% of LAS



+



5-6 RSUs
Max: 0.05 W/cm²
Min: 0.03 W/cm²

LEC
Max: 0.72 W/cm²
Min: 0.48 W/cm²

Total power (6 RSUs)
Max: 1.89 W
Min: 1.21 W

MOSAIX: same power densities as EIC-LAS